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Designer's™ Data Sheet

Insulated Gate Bipolar Transistor with Anti-Parallel Diode

N–Channel Enhancement–Mode Silicon Gate

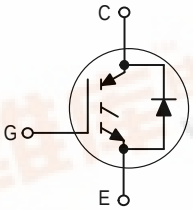
MGY20N120D

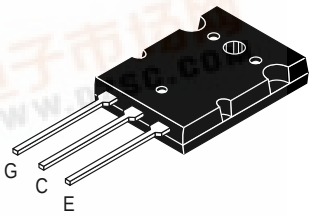
Motorola Preferred Device

IGBT & DIODE IN TO–264
20 A @ 90°C
28 A @ 25°C
1200 VOLTS
SHORT CIRCUIT RATED

This Insulated Gate Bipolar Transistor (IGBT) is co–packaged with a soft recovery ultra–fast rectifier and uses an advanced termination scheme to provide an enhanced and reliable high voltage–blocking capability. Short circuit rated IGBT's are specifically suited for applications requiring a guaranteed short circuit withstand time such as Motor Control Drives. Fast switching characteristics result in efficient operation at high frequencies. Co–packaged IGBT's save space, reduce assembly time and cost.

- Industry Standard High Power TO–264 Package (TO–3PBL)
- High Speed E_{off}: 160 μJ per Amp typical at 125°C
- High Short Circuit Capability – 10 μs minimum
- Soft Recovery Free Wheeling Diode is included in the package
- Robust High Voltage Termination
- Robust RBSOA





CASE 340G–02, Style 5
TO–264

MAXIMUM RATINGS (T_J = 25°C unless otherwise noted)

Rating	Symbol	Value	Unit
Collector–Emitter Voltage	V_{CES}	1200	Vdc
Collector–Gate Voltage (R_{GE} = 1.0 MΩ)	V_{CGR}	1200	Vdc
Gate–Emitter Voltage — Continuous	V_{GE}	±20	Vdc
Collector Current — Continuous @ T_C = 25°C — Continuous @ T_C = 90°C — Repetitive Pulsed Current (1)	I_{C25} I_{C90} I_{CM}	28 20 56	Adc Apk
Total Power Dissipation @ T_C = 25°C Derate above 25°C	P_D	174 1.39	Watts W/°C
Operating and Storage Junction Temperature Range	T_J, T_{stg}	–55 to 150	°C
Short Circuit Withstand Time (V_{CC} = 720 Vdc, V_{GE} = 15 Vdc, T_J = 125°C, R_G = 20 Ω)	t_{sc}	10	μs
Thermal Resistance — Junction to Case – IGBT — Junction to Case – Diode — Junction to Ambient	$R_{\theta JC}$ $R_{\theta JC}$ $R_{\theta JA}$	0.7 1.1 35	°C/W
Maximum Lead Temperature for Soldering Purposes, 1/8″ from case for 5 seconds	T_L	260	°C
Mounting Torque, 6–32 or M3 screw	10 lbf•in (1.13 N•m)		

(1) Pulse width is limited by maximum junction temperature. Repetitive rating.

Designer's Data for "Worst Case" Conditions — The Designer's Data Sheet permits the design of most circuits entirely from the information presented. SOA Limit curves — representing boundaries on device characteristics — are given to facilitate "worst case" design.

Preferred devices are Motorola recommended choices for future use and best overall value.

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ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise noted)

Characteristic		Symbol	Min	Typ	Max	Unit
OFF CHARACTERISTICS						
Collector–to–Emitter Breakdown Voltage (V_{GE} = 0 Vdc, I_C = 25 μAdc) Temperature Coefficient (Positive)		BV_{CES}	 1200 —	 — 870	 — —	Vdc mV/°C
Zero Gate Voltage Collector Current (V_{CE} = 1200 Vdc, V_{GE} = 0 Vdc) (V_{CE} = 1200 Vdc, V_{GE} = 0 Vdc, T_J = 125°C)		I_{CES}	 — —	 — —	 100 2500	μAdc
Gate–Body Leakage Current (V_{GE} = ± 20 Vdc, V_{CE} = 0 Vdc)		I_{GES}	—	—	250	nAdc
ON CHARACTERISTICS (1)						
Collector–to–Emitter On–State Voltage (V_{GE} = 15 Vdc, I_C = 10 Adc) (V_{GE} = 15 Vdc, I_C = 10 Adc, T_J = 125°C) (V_{GE} = 15 Vdc, I_C = 20 Adc)		$V_{CE(on)}$	 — — —	 3.00 2.36 2.90	 3.54 — 4.99	Vdc
Gate Threshold Voltage (V_{CE} = V_{GE}, I_C = 1.0 mAdc) Threshold Temperature Coefficient (Negative)		$V_{GE(th)}$	 4.0 —	 6.0 10	 8.0 —	Vdc mV/°C
Forward Transconductance (V_{CE} = 10 Vdc, I_C = 20 Adc)		g_{fe}	—	12	—	Mhos
DYNAMIC CHARACTERISTICS						
Input Capacitance	(V_{CE} = 25 Vdc, V_{GE} = 0 Vdc, f = 1.0 MHz)	C_{ies}	—	1876	—	pF
Output Capacitance		C_{oes}	—	208	—	
Transfer Capacitance		C_{res}	—	31	—	
SWITCHING CHARACTERISTICS (1)						
Turn–On Delay Time	(V_{CC} = 720 Vdc, I_C = 20 Adc, V_{GE} = 15 Vdc, L = 300 μH R_G = 20 Ω, T_J = 25°C) Energy losses include "tail"	$t_{d(on)}$	—	88	—	ns
Rise Time		t_r	—	103	—	
Turn–Off Delay Time		$t_{d(off)}$	—	190	—	
Fall Time		t_f	—	284	—	
Turn–Off Switching Loss		E_{off}	—	1.65	3.75	mJ
Turn–On Switching Loss		E_{on}	—	2.42	7.68	
Total Switching Loss		E_{ts}	—	4.07	11.43	
Turn–On Delay Time	(V_{CC} = 720 Vdc, I_C = 20 Adc, V_{GE} = 15 Vdc, L = 300 μH R_G = 20 Ω, T_J = 125°C) Energy losses include "tail"	$t_{d(on)}$	—	83	—	ns
Rise Time		t_r	—	107	—	
Turn–Off Delay Time		$t_{d(off)}$	—	216	—	
Fall Time		t_f	—	494	—	
Turn–Off Switching Loss		E_{off}	—	3.19	—	mJ
Turn–On Switching Loss		E_{on}	—	4.26	—	
Total Switching Loss		E_{ts}	—	7.45	—	
Gate Charge	(V_{CC} = 720 Vdc, I_C = 20 Adc, V_{GE} = 15 Vdc)	Q_T	—	63	—	nC
		Q_1	—	20	—	
		Q_2	—	27	—	
DIODE CHARACTERISTICS						
Diode Forward Voltage Drop (I_{EC} = 10 Adc) (I_{EC} = 10 Adc, T_J = 125°C) (I_{EC} = 20 Adc)		V_{FEC}	 — — —	 2.92 1.73 3.67	 3.59 — 4.57	Vdc

(1) Pulse Test: Pulse Width ≤ 300 μs, Duty Cycle ≤ 2%.

(continued)

ELECTRICAL CHARACTERISTICS — continued (T_J = 25°C unless otherwise noted)

Characteristic		Symbol	Min	Typ	Max	Unit
DIODE CHARACTERISTICS — continued						
Reverse Recovery Time	(I_F = 20 Adc, V_R = 720 Vdc, dI_F/dt = 150 A/µs)	t_{rr}	—	114	—	ns
		t_a	—	74	—	
		t_b	—	40	—	
Reverse Recovery Stored Charge		Q_{RR}	—	0.68	—	µC
Reverse Recovery Time	(I_F = 20 Adc, V_R = 720 Vdc, dI_F/dt = 150 A/µs, T_J = 125°C)	t_{rr}	—	224	—	ns
		t_a	—	149	—	
		t_b	—	75	—	
Reverse Recovery Stored Charge		Q_{RR}	—	2.40	—	µC
INTERNAL PACKAGE INDUCTANCE						
Internal Emitter Inductance (Measured from the emitter lead 0.25″ from package to emitter bond pad)		L_E	—	13	—	nH

TYPICAL ELECTRICAL CHARACTERISTICS

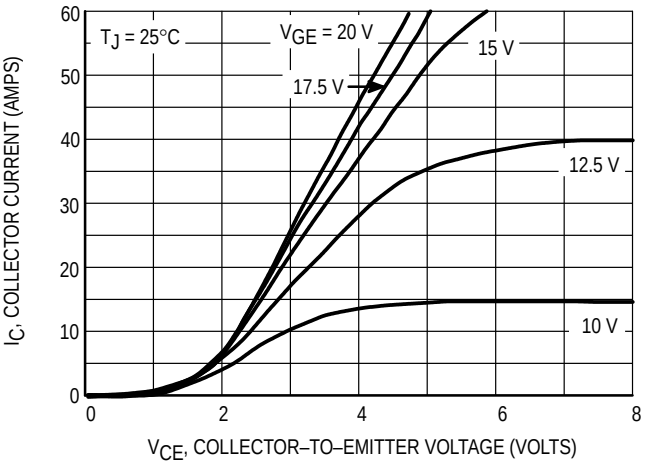


Figure 1. Output Characteristics, T_J = 25°C

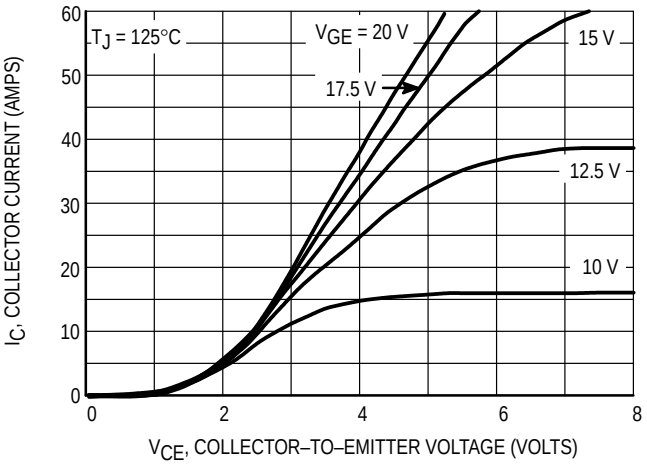


Figure 2. Output Characteristics, T_J = 125°C

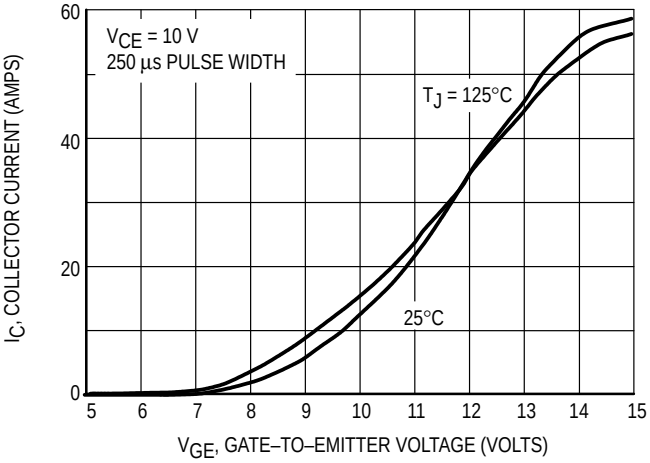


Figure 3. Transfer Characteristics

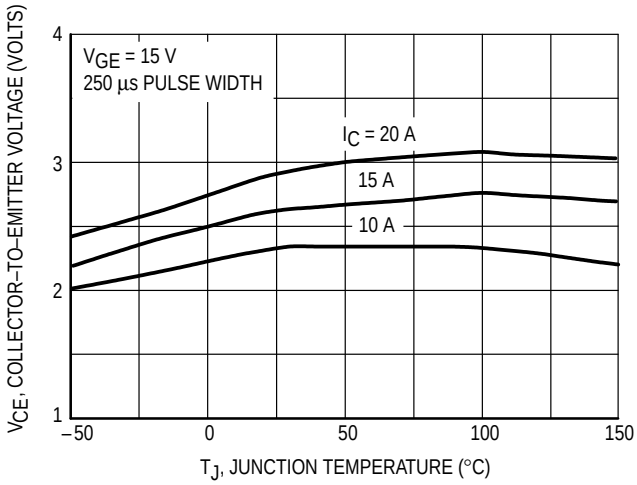


Figure 4. Collector–to–Emitter Saturation Voltage versus Junction Temperature

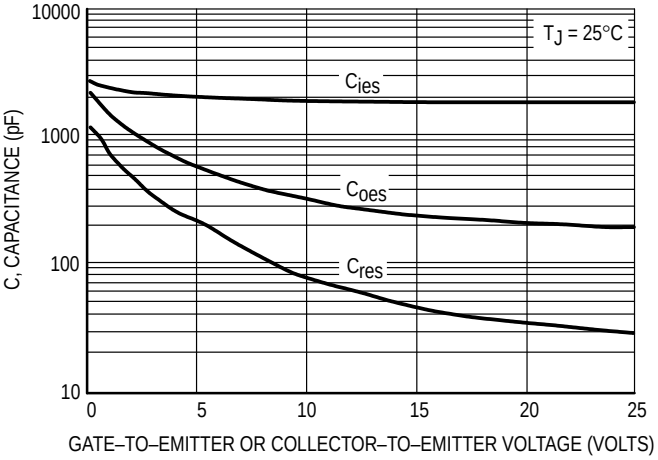


Figure 5. Capacitance Variation

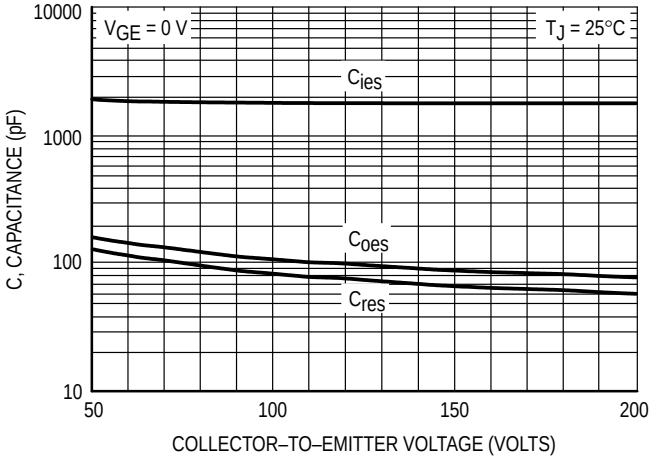


Figure 5b. High Voltage Capacitance Variation

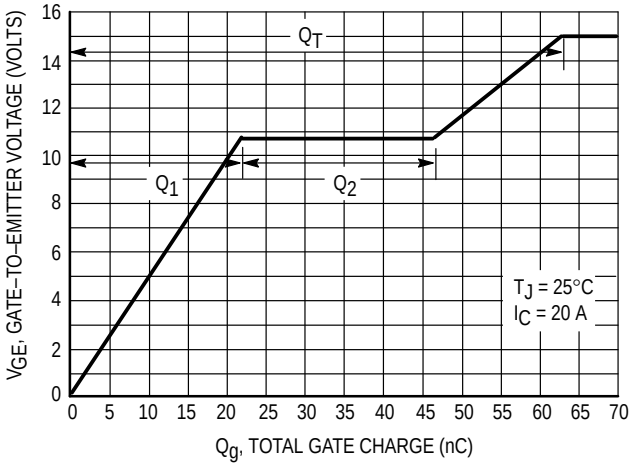


Figure 6. Gate–to–Emitter and Collector–to–Emitter Voltage versus Total Charge

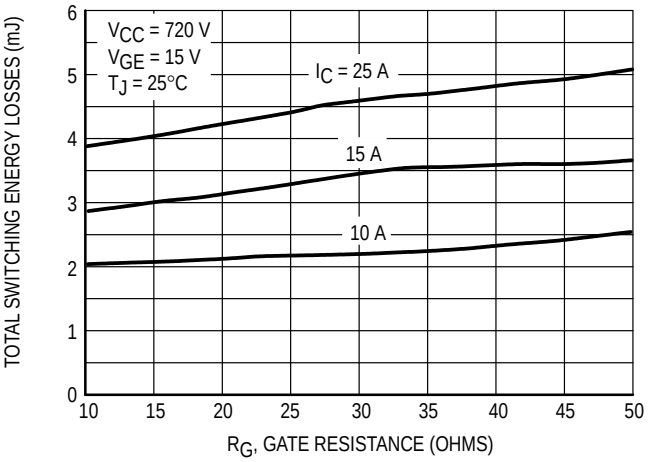


Figure 7. Total Switching Losses versus Gate Resistance

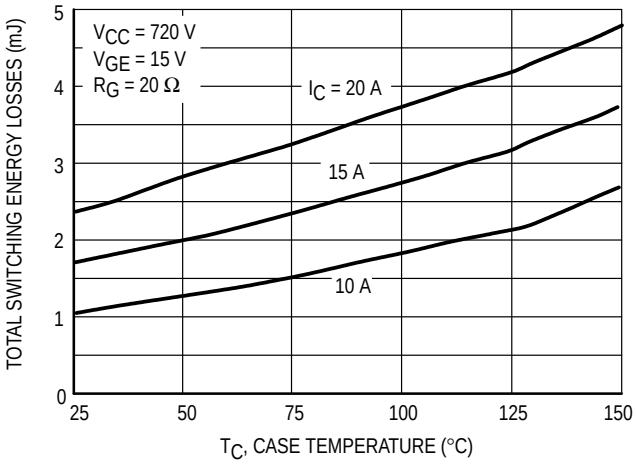


Figure 8. Total Switching Losses versus Case Temperature

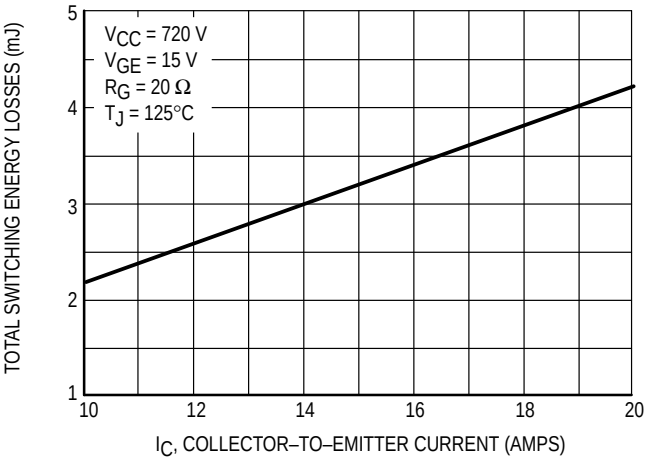


Figure 9. Total Switching Losses versus Collector–to–Emitter Current

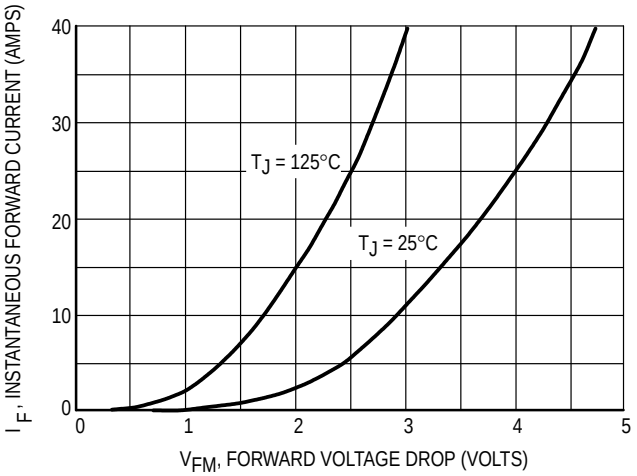


Figure 10. Maximum Forward Drop versus Instantaneous Forward Current

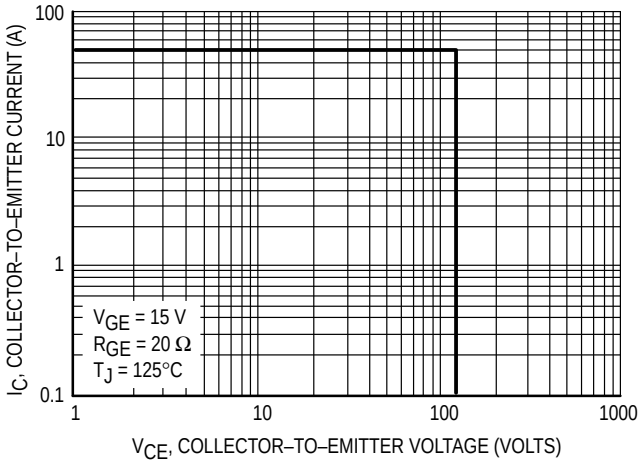


Figure 11. Reverse Biased Safe Operating Area

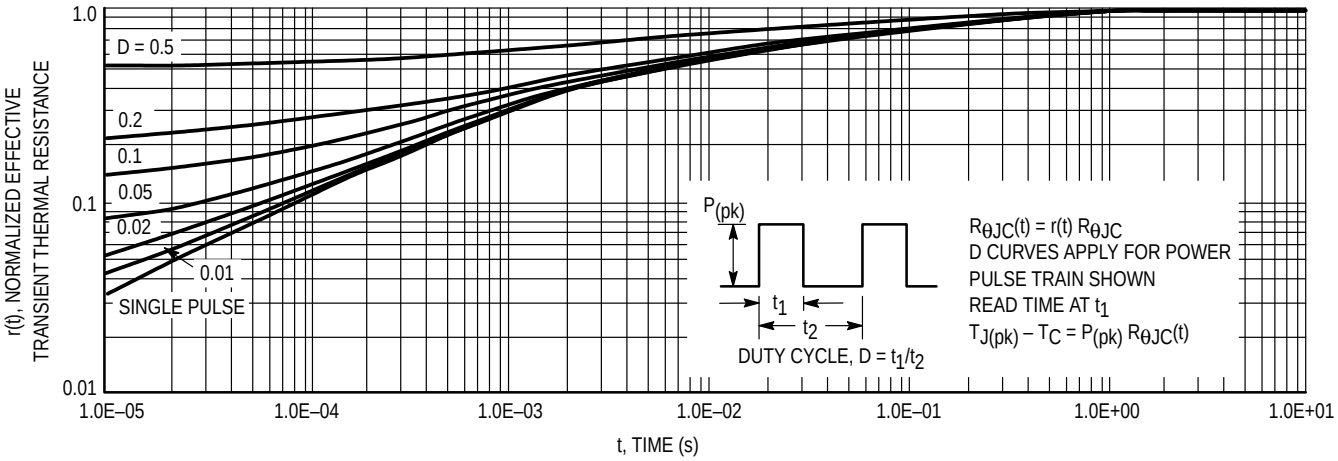
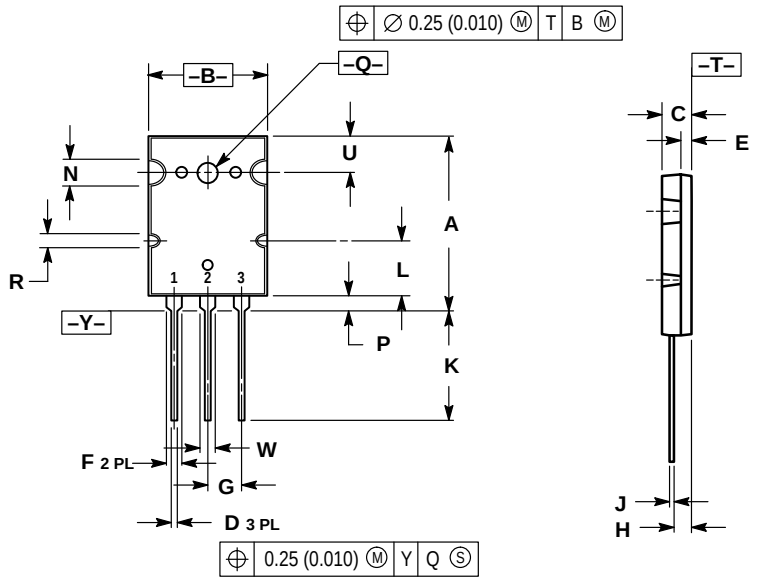


Figure 12. Thermal Response

PACKAGE DIMENSIONS



NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETER.

	MILLIMETERS		INCHES	
DIM	MIN	MAX	MIN	MAX
A	2.8	2.9	1.102	1.142
B	19.3	20.3	0.760	0.800
C	4.7	5.3	0.185	0.209
D	0.93	1.48	0.037	0.058
E	1.9	2.1	0.075	0.083
F	2.2	2.4	0.087	0.102
G	5.45 BSC		0.215 BSC	
H	2.6	3.0	0.102	0.118
J	0.43	0.78	0.017	0.031
K	17.6	18.8	0.693	0.740
L	11.0	11.4	0.433	0.449
N	3.95	4.75	0.156	0.187
P	2.2	2.6	0.087	0.102
Q	3.1	3.5	0.122	0.137
R	2.15	2.35	0.085	0.093
U	6.1	6.5	0.240	0.256
W	2.8	3.2	0.110	0.125

STYLE 5:
PIN 1. GATE
2. COLLECTOR
3. EMITTER

CASE 340G–02
TO–264
ISSUE E

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